



IECQ Certificate of Conformity Manufacturer

IECQ Certificate No.:	IECQ-P VDE 19.0002	Issue No.:	6	Status:	Current
Supersedes:	IECQ-P VDE 19.0002 Issue 5	Issue Date:	2021/12/13	Org Issue:	2018/11/26
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ABB STOTZ-KONTAKT GmbH

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The organization has developed and implemented procedures and related processes which have been assessed by the IECQ Certification Body issuing this certificate and found to comply with the applicable requirements of the IECQ Approved Process Scheme which is in accordance with the Basic Rules IECQ 01 "Rules of Procedure", IECQ 03-1 "IECQ General Requirements for all Schemes" & IECQ 03-2 "IECQ Approved Process Scheme" of the IEC Quality Assessment System for Electronic Components (IECQ), and in respect of standard(s) or specification(s):

- **IPC-JEDEC J-STD-020E {Dec 2014}** Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices
- **IPC-JEDEC J-STD-033D {April 2018}** IPC-JEDEC Standard for handling, packing, shipping, and use of moisture/reflow sensitive surface-mount devices
- **JEDEC-JEP 113-B {01-May-1999}** Symbol and Labels for Moisture-Sensitive Devices

Process Manual Reference: **IMS QMH dated 2020-07-06**

Scope of Activity:

Dry-Pack Packing System from goods receiving till shipping

Issued by the Certification Body: VDE Testing and Certification Institute

Merianstrasse 28
63069 OFFENBACH
Germany

Authorized person:
Dr. Kreß

VDE
INSTITUTE



The validity of this certificate is maintained through on-going surveillance audits by the IECQ CB issuing this certificate.
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